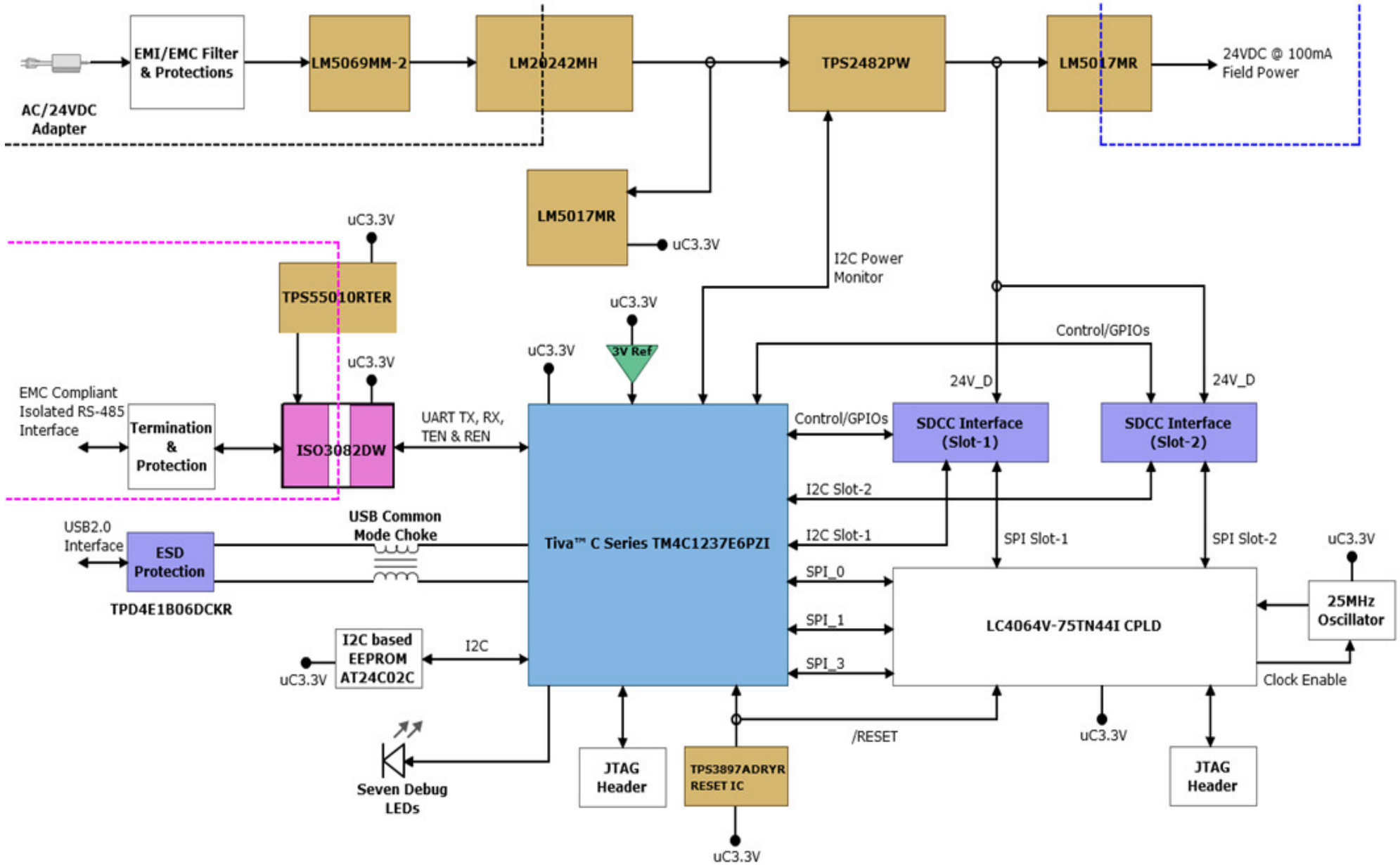
*BLOCK DIAGRAM:*

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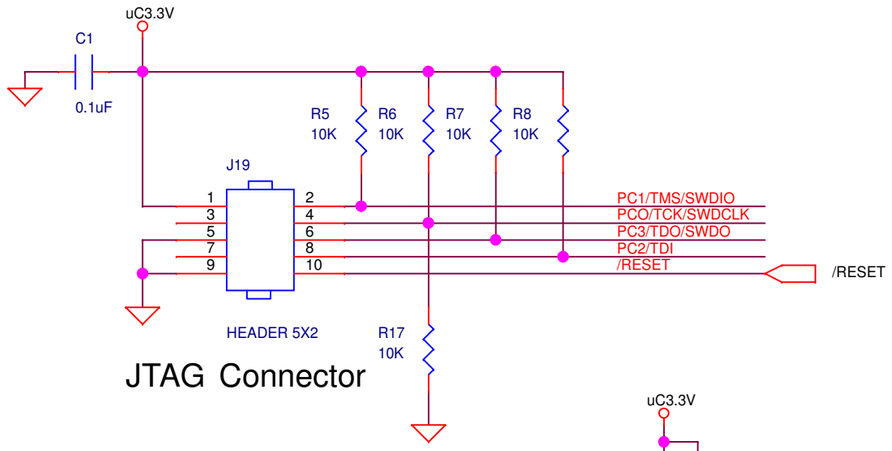
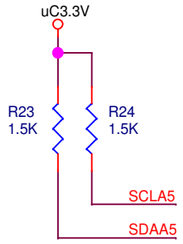
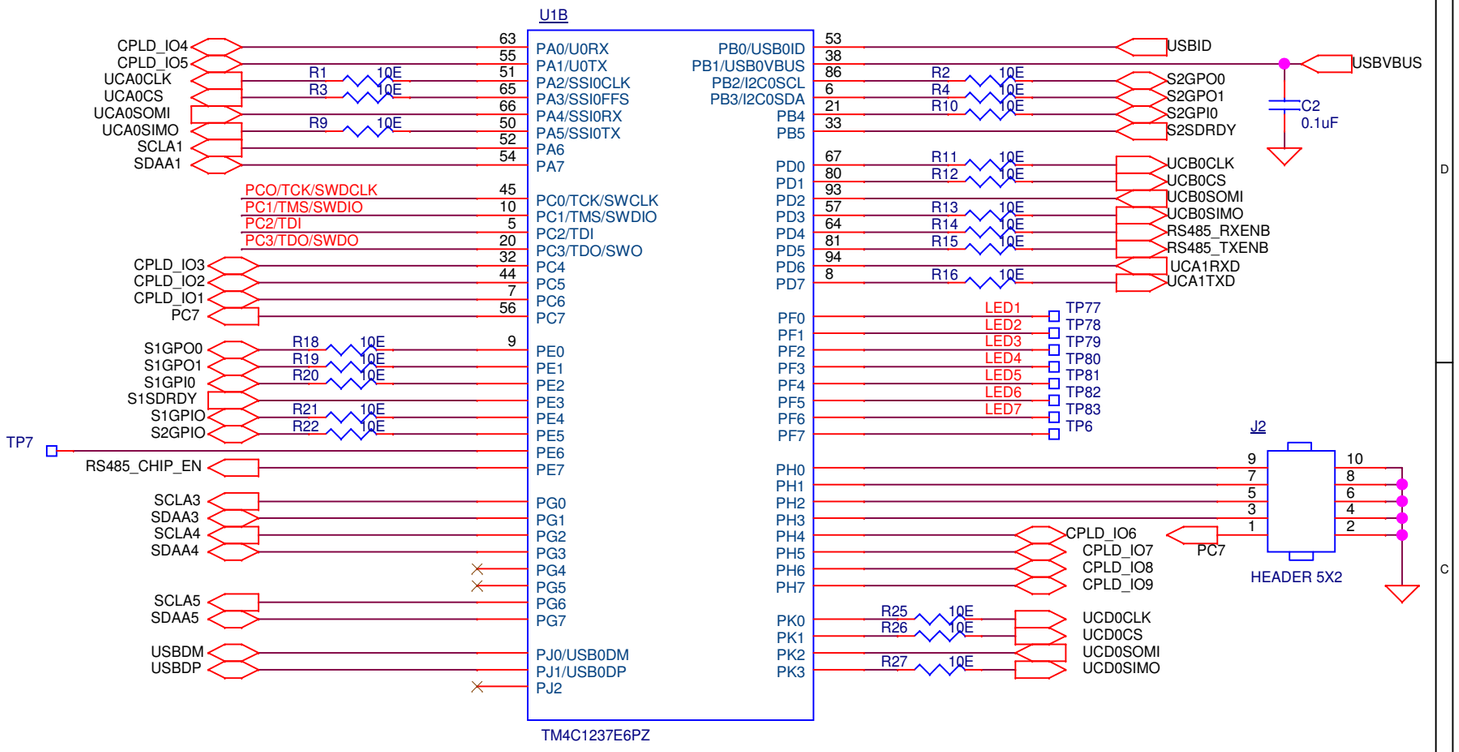
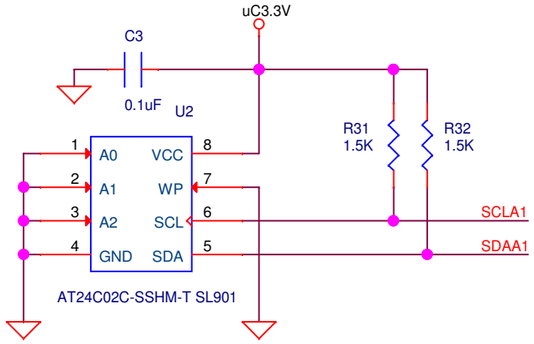
| Title | TIDA-00123 - PROGRAMMABLE LOGIC CONTROLLER (PLC) I/O MODULE FRONT-END CONTROLLER | |
| Size B | Document Number TIDA-00123 | Rev E1 |
| Date: Friday, January 31, 2014 | Sheet 1 of 9 | |




## JTAG Connector

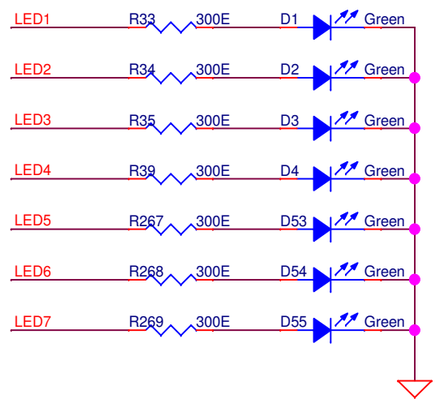



## I2C EEPROM

## DEBUG LEDs




FID1 FID2 FID3 FID4
FID5 FID6 FID7 FID8

MH1 MH2 MH3 MH4
MH 3.2MM MH 3.2MM MH 3.2MM MH 3.2MM

MH5 MH6 MH7 MH8 MH9 MH10 MH11 MH12
MH 3.2MM MH 3.2MM MH 3.2MM MH 3.2MM MH 3.2MM MH 3.2MM MH 3.2MM MH 3.2MM

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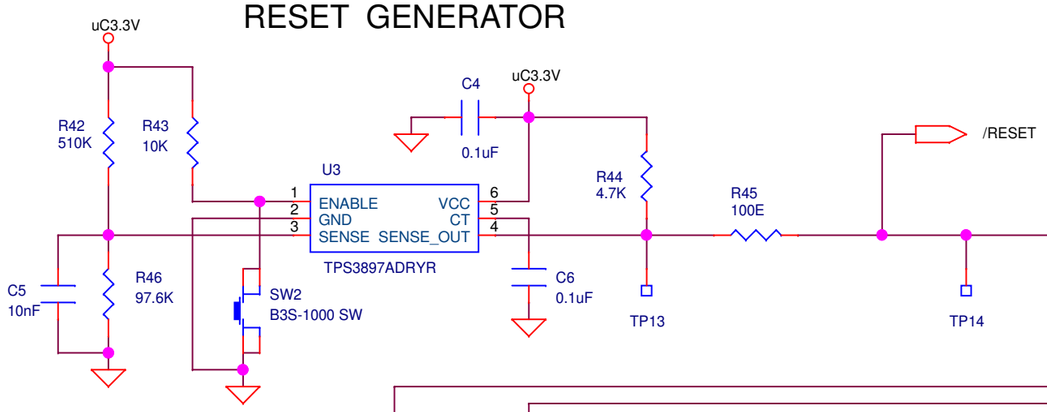
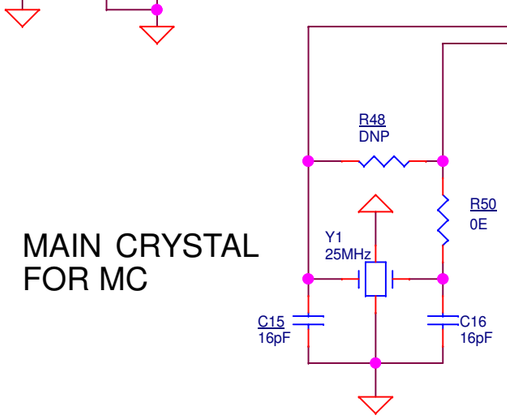
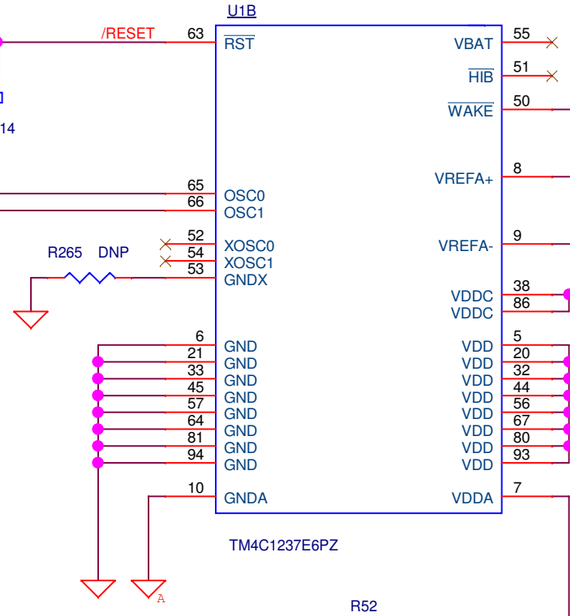
| Title | TIDA-00123 - PROGRAMMABLE LOGIC CONTROLLER (PLC) I/O MODULE FRONT-END CONTROLLER | |
| Size B | Document Number TIDA-00123 | Rev E1 |
| Date: Friday, January 31, 2014 | Sheet 2 of 9 | |

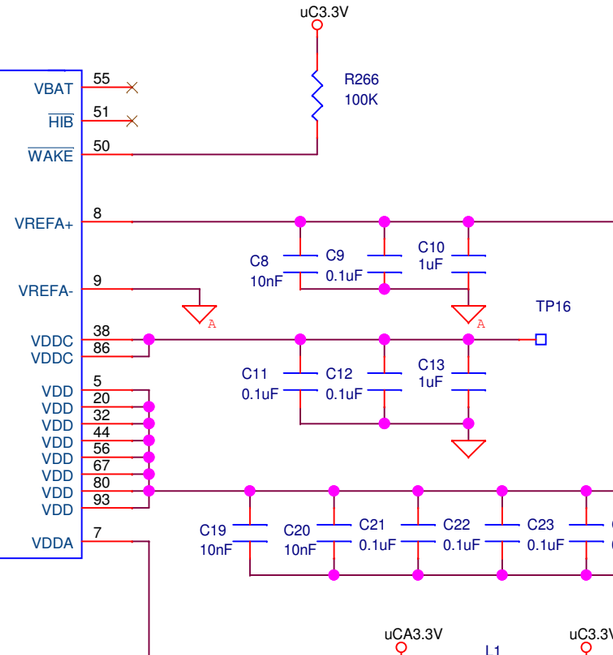
# RESET GENERATOR

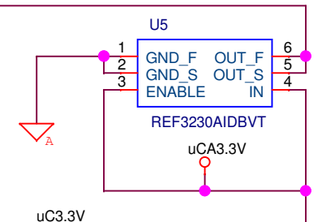



MAIN CRYSTAL
FOR MC

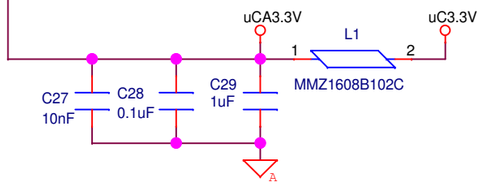


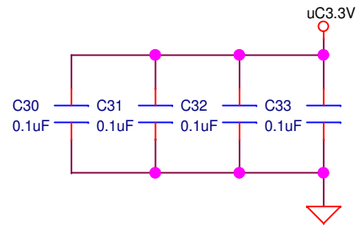



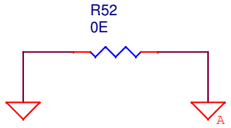



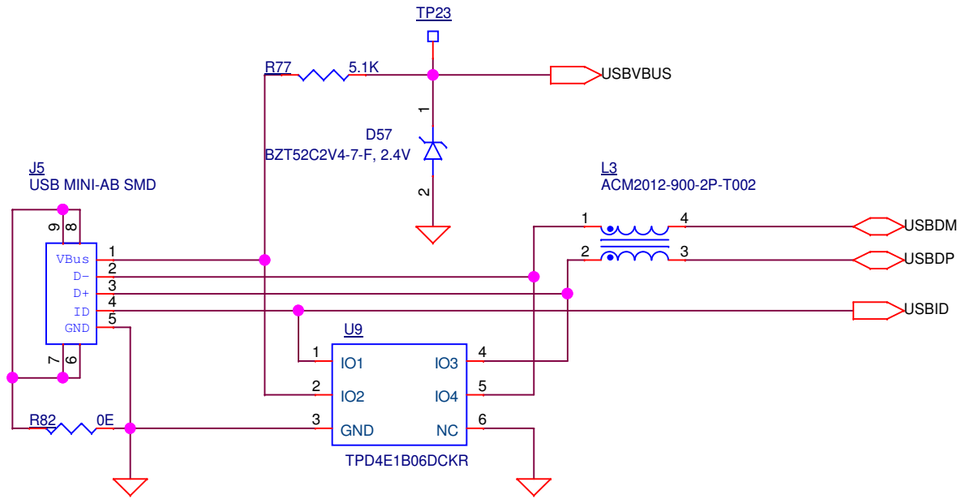







USB Interface

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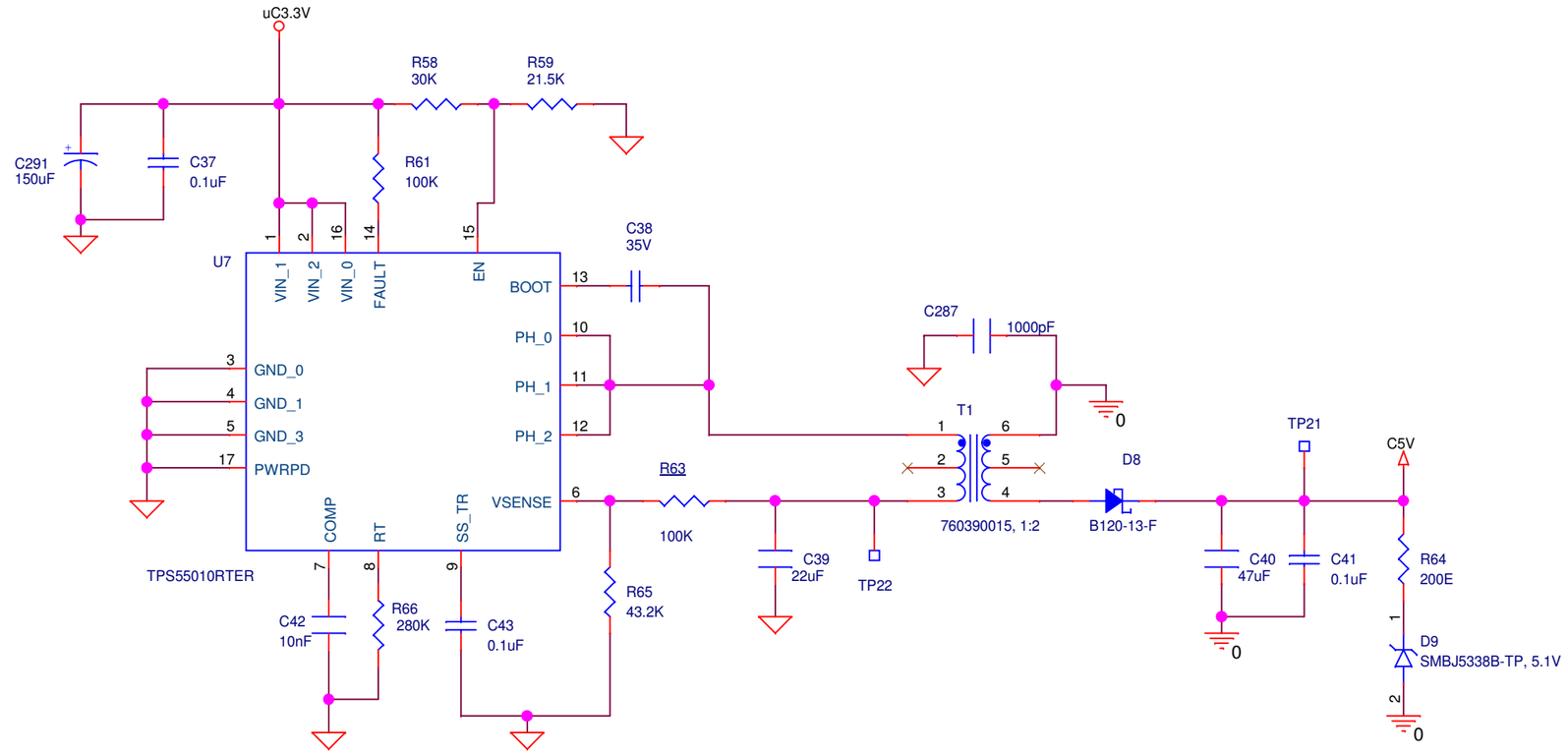
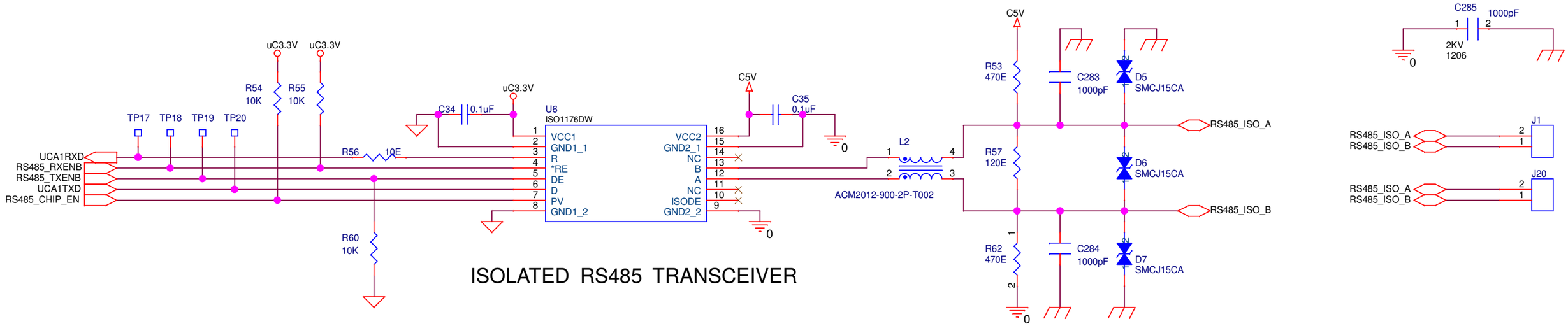
| Size B | Document Number TIDA-00123 | Rev E1 |
| Date: Friday, January 31, 2014 | Sheet 3 of 9 | |




# ISOLATED DC/DC CONVERTER FOR RS485




# ISOLATED RS485 TRANSCEIVER

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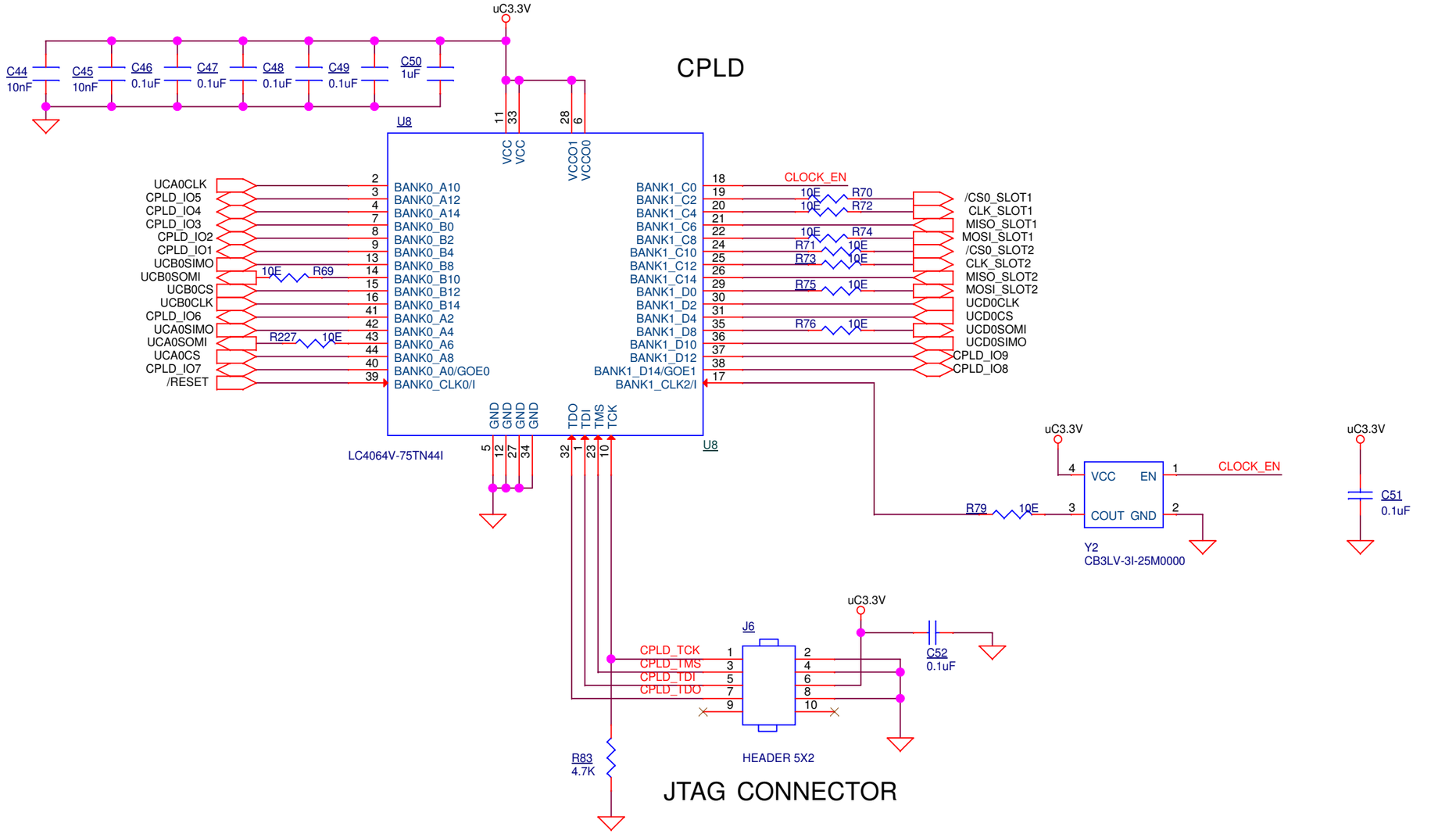
| Size B | Document Number TIDA-00123 | Rev E1 |
| Date: Friday, January 31, 2014 | Sheet 4 of 9 | |

# CPLD




# JTAG CONNECTOR

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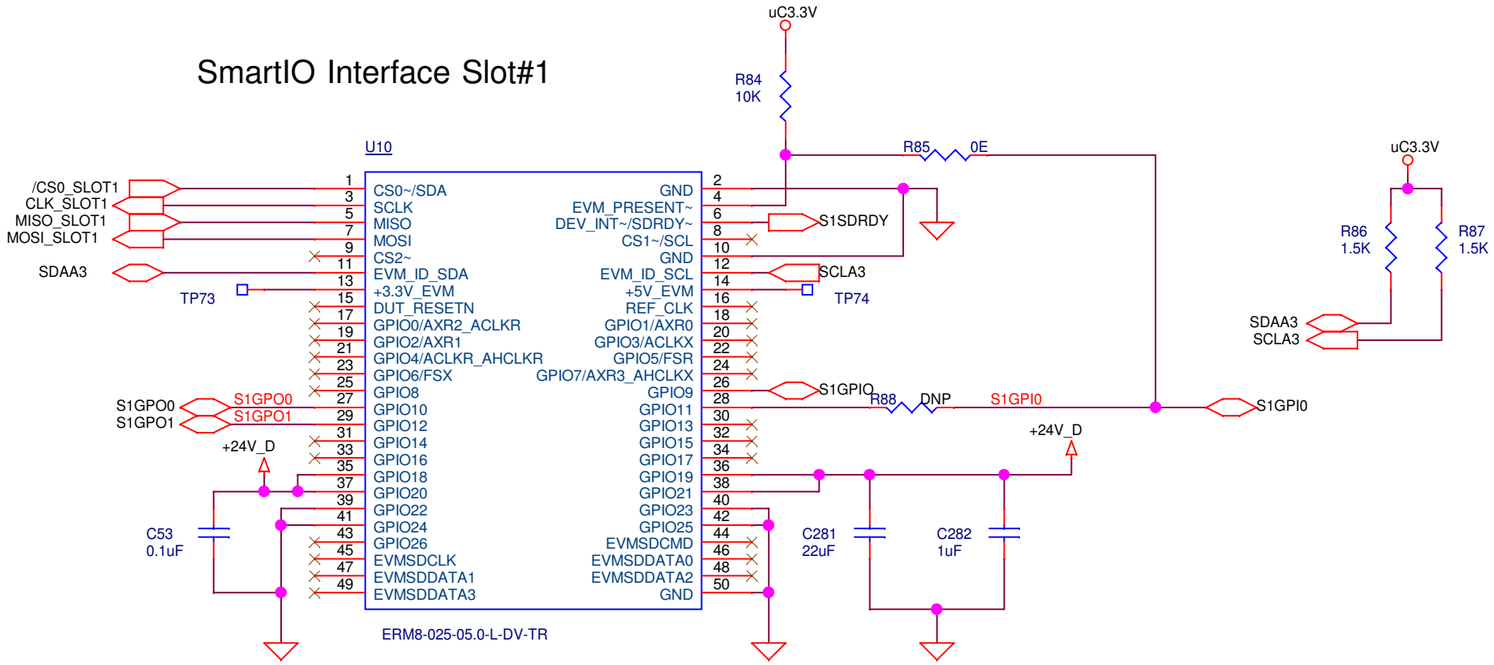
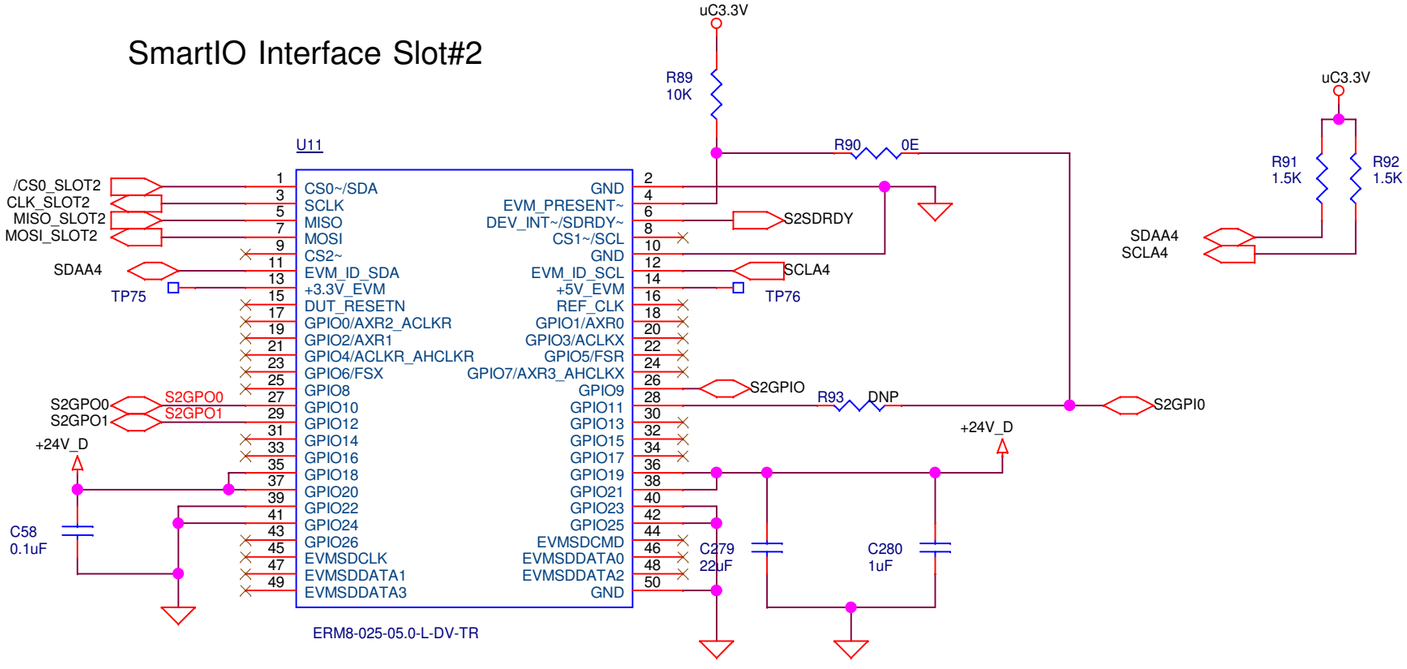
| Size B | Document Number TIDA-00123 | | Rev E1 |
| Date: Friday, January 31, 2014 | Sheet 5 of 9 | | |

## SmartIO Interface Slot#1




## SmartIO Interface Slot#2

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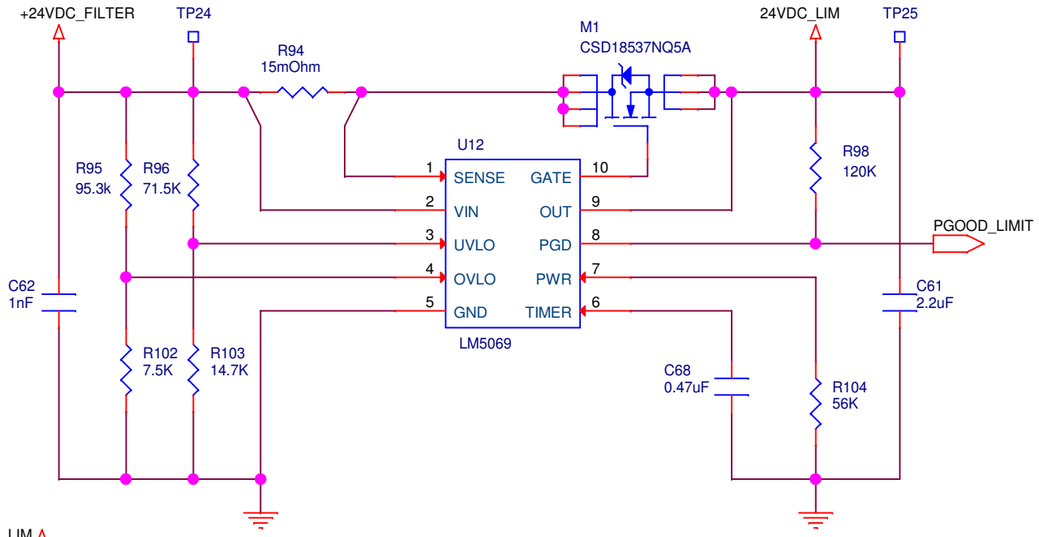
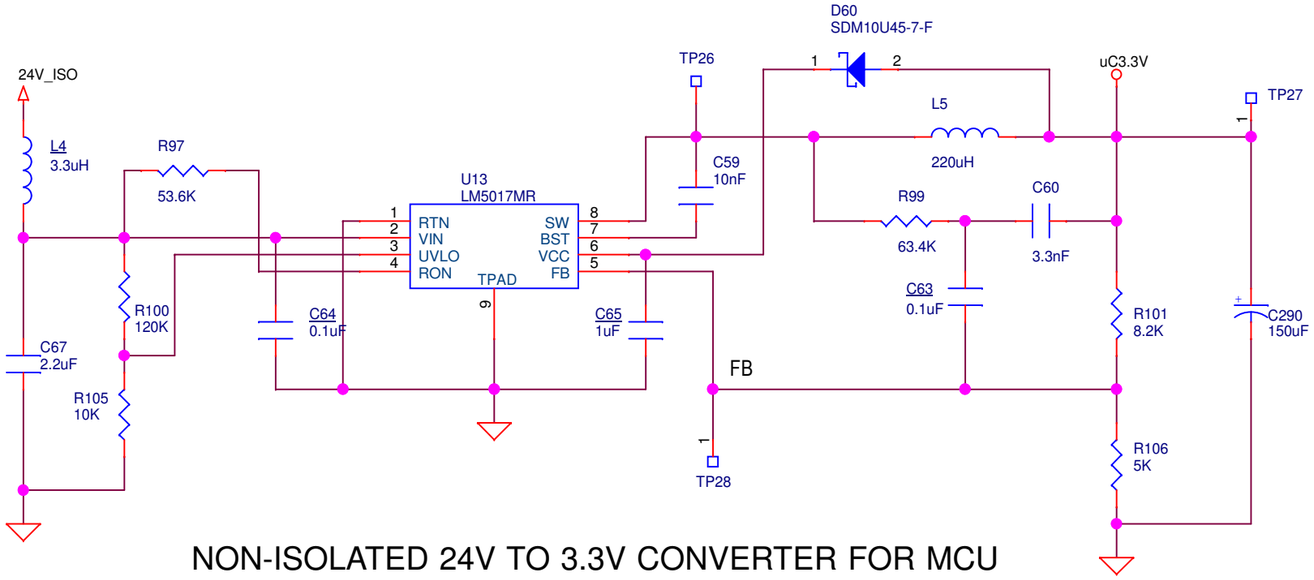
| Size B | Document Number: TIDA-00123 — Rev E1 |
| Date: Friday, January 31, 2014 | Sheet 6 of 9 |

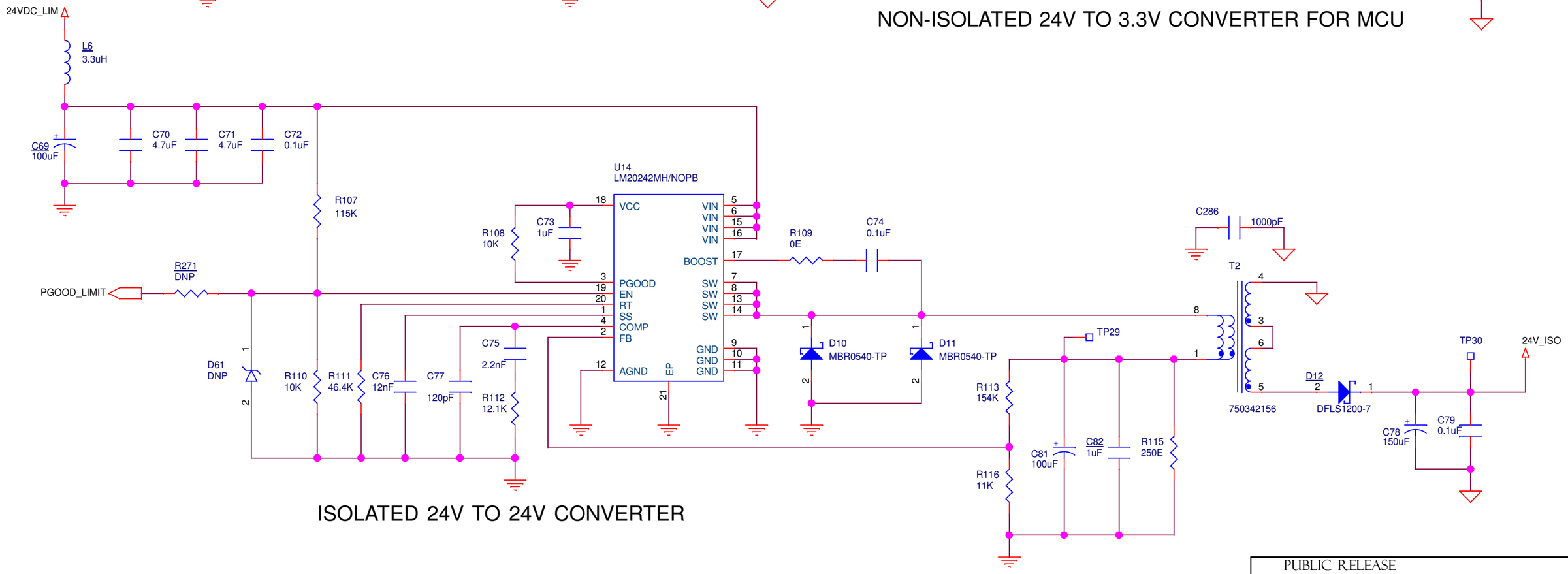
## CURRENT LIMIT & HOT SWAP




## NON-ISOLATED 24V TO 3.3V CONVERTER FOR MCU




## ISOLATED 24V TO 24V CONVERTER

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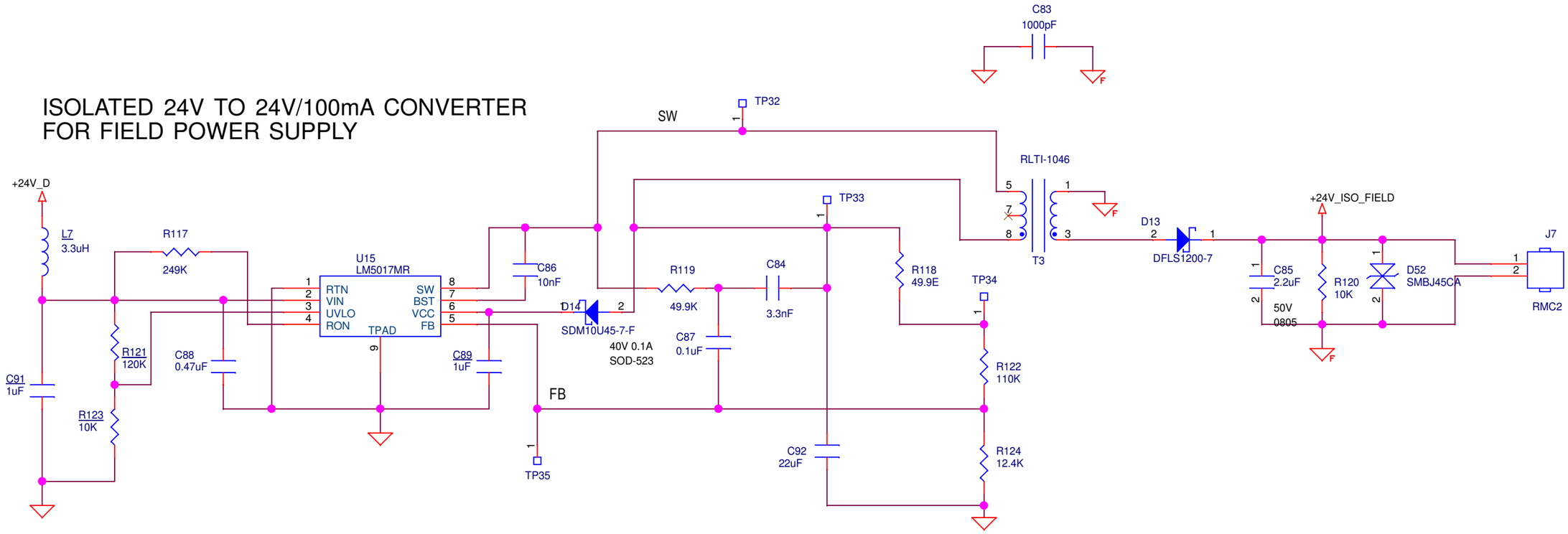
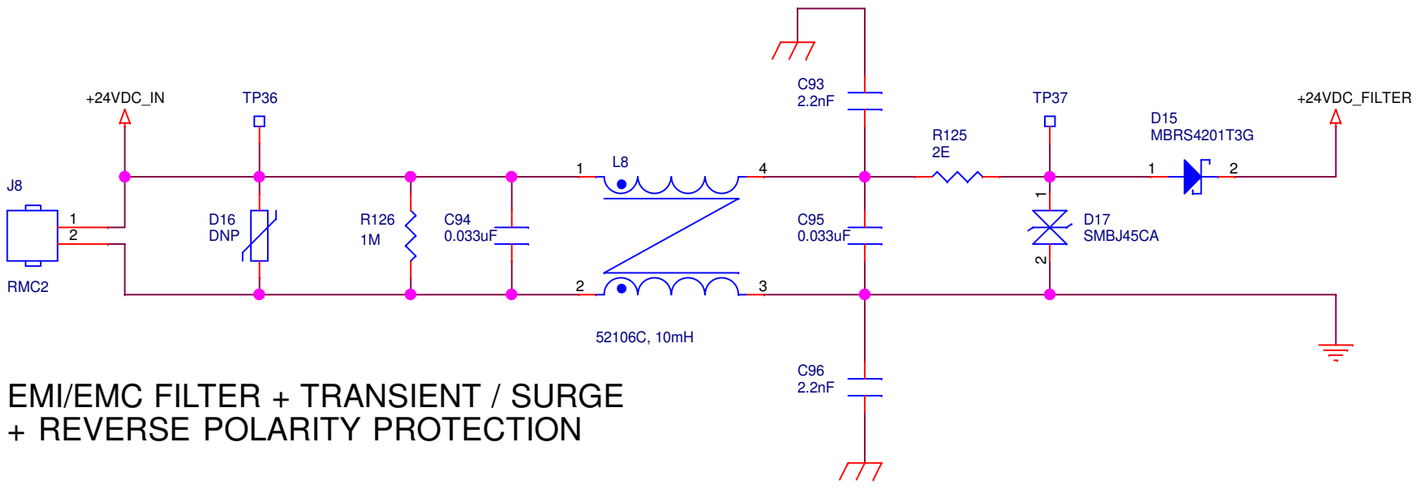
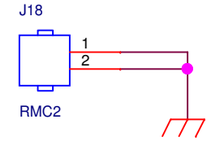
| Title | TIDA-00123 - PROGRAMMABLE LOGIC CONTROLLER (PLC) I/O MODULE FRONT-END CONTROLLER | |
| Size B | Document Number TIDA-00123 | Rev E1 |
| Date: Friday, January 31, 2014 | Sheet 7 of 9 | |

# ISOLATED 24V TO 24V/100mA CONVERTER FOR FIELD POWER SUPPLY




## EMI/EMC FILTER + TRANSIENT / SURGE + REVERSE POLARITY PROTECTION




Protective Earth or Chassis

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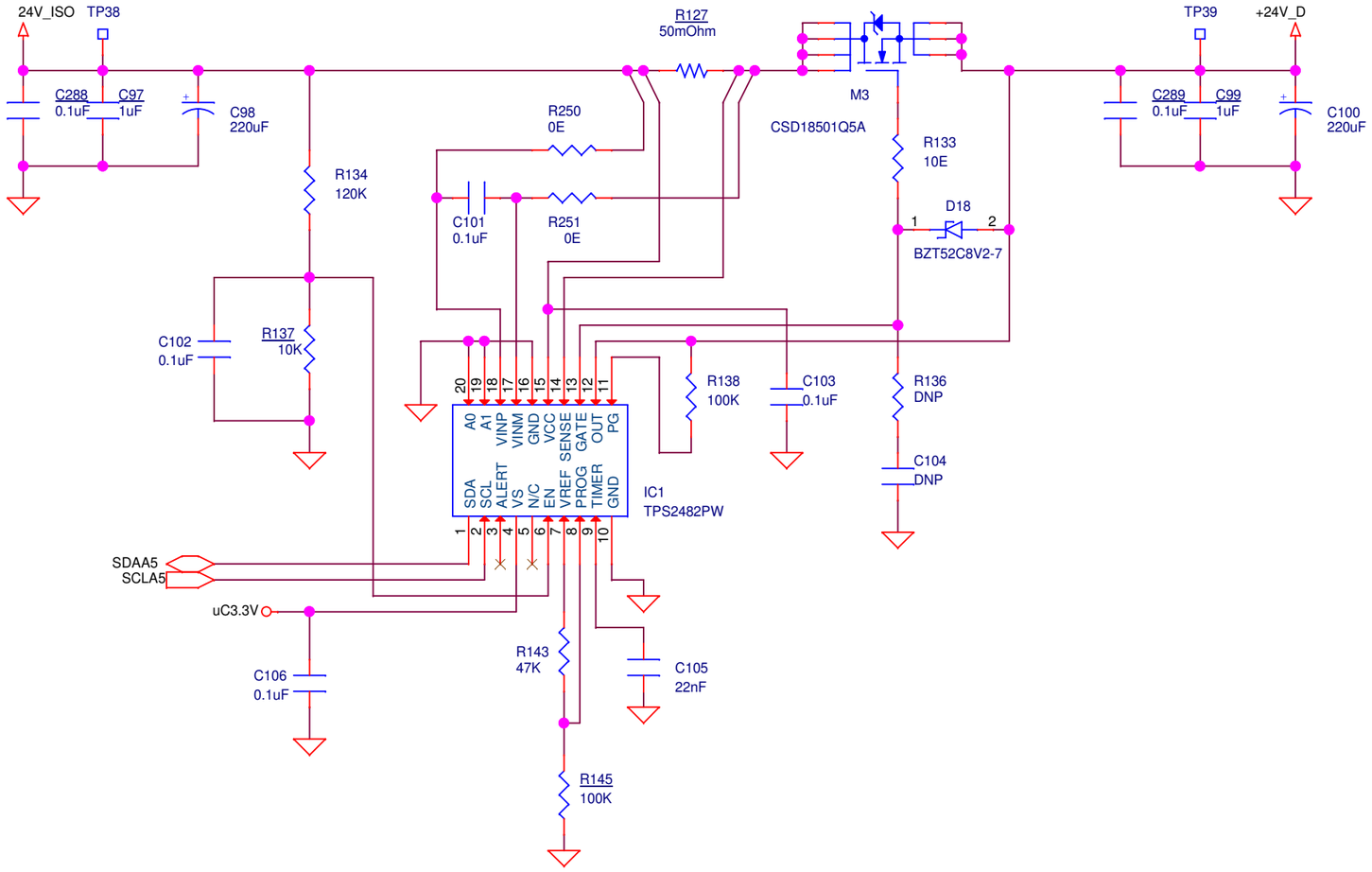
| Title | TIDA-00123 - PROGRAMMABLE LOGIC CONTROLLER (PLC) I/O MODULE FRONT-END CONTROLLER | |
| Size B | Document Number TIDA-00123 | Rev E1 |
| Date: Friday, January 31, 2014 | Sheet 8 of 9 | |

# HOTSWAP CONTROLLER WITH I2C POWER MONITORING

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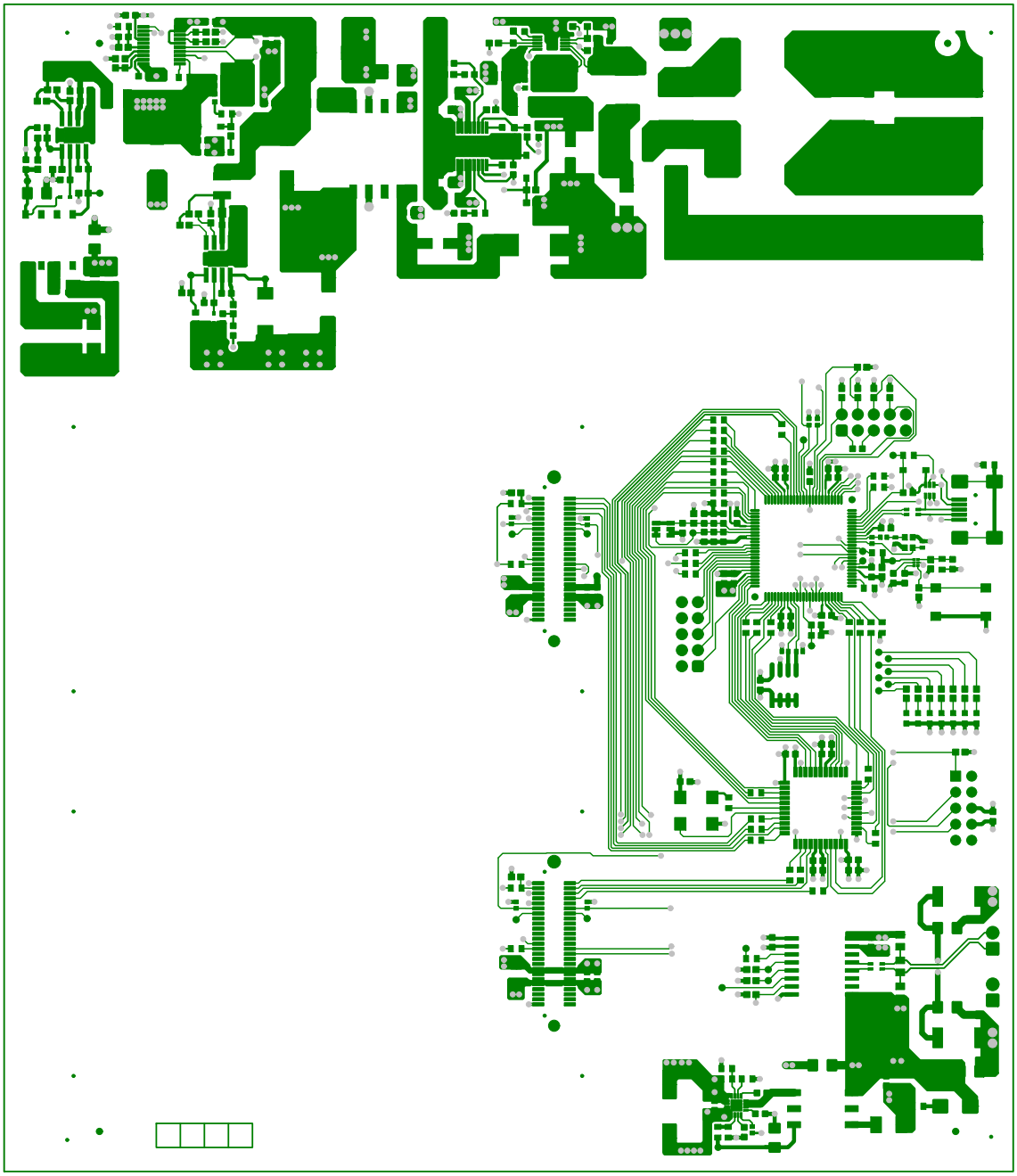
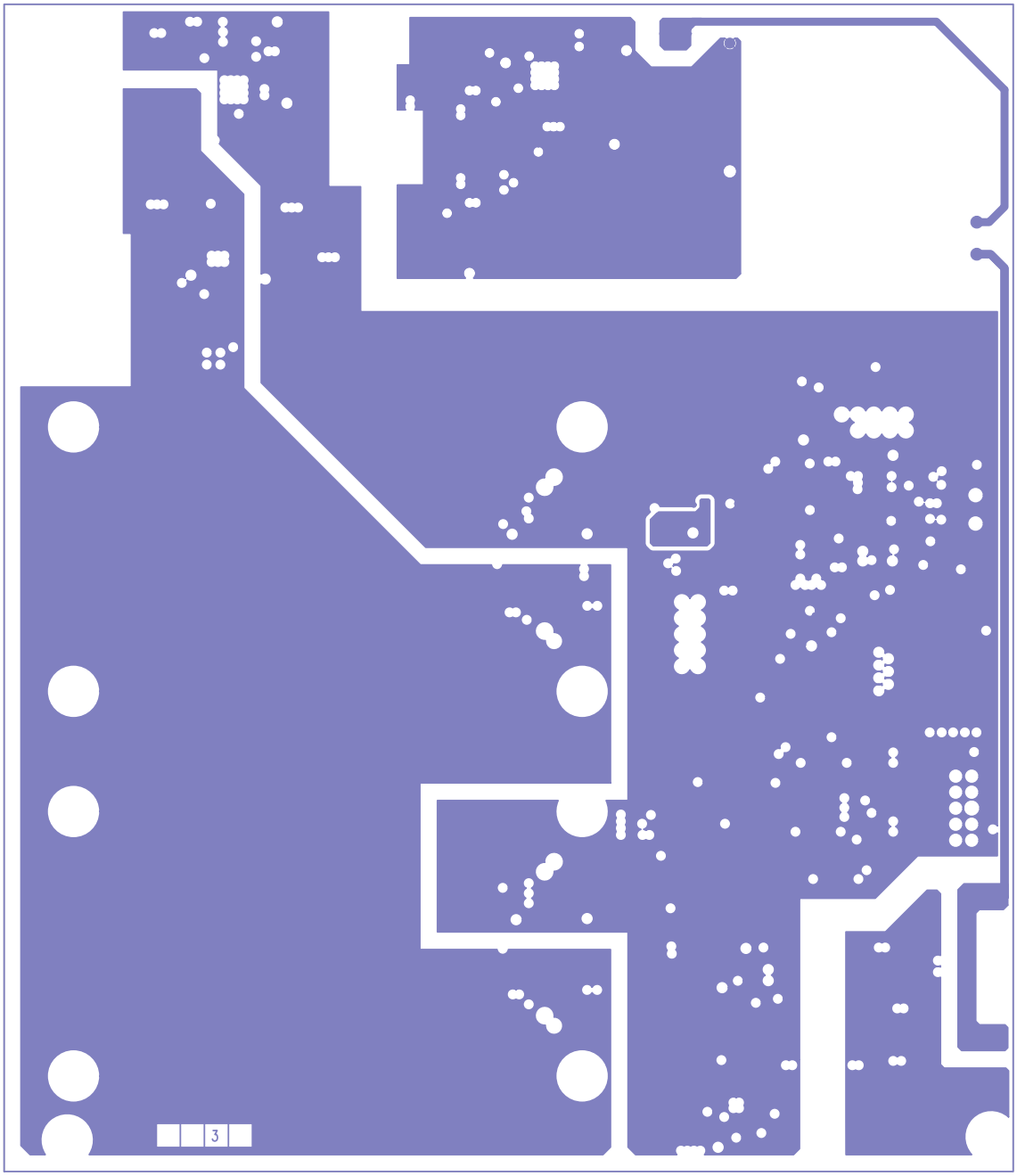
| Title | TIDA-00123 - PROGRAMMABLE LOGIC CONTROLLER (PLC) I/O MODULE FRONT-END CONTROLLER | |
| Size B | Document Number TIDA-00123 | Rev E1 |
| Date: Friday, January 31, 2014 | Sheet 9 of 9 | |

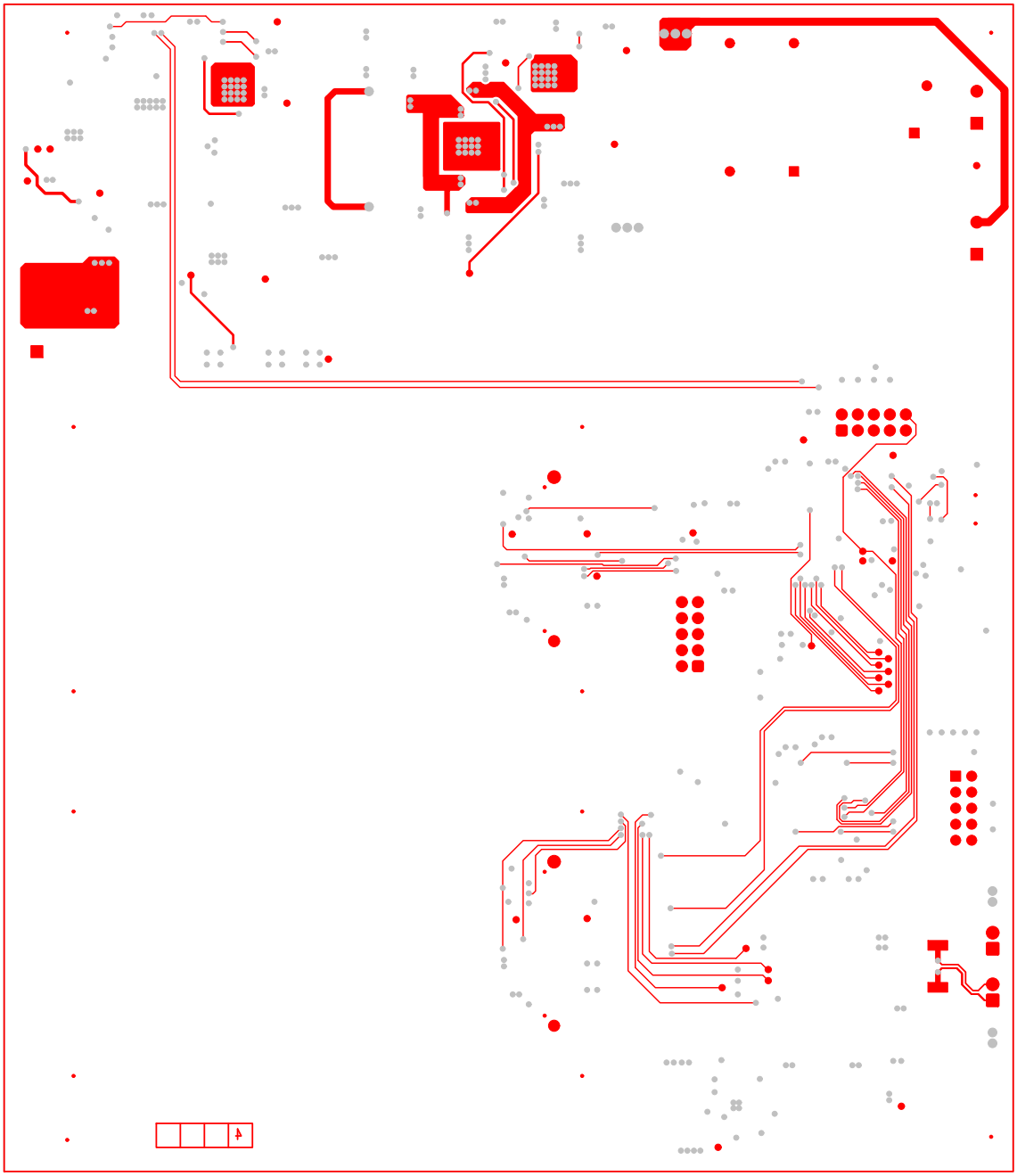


TOP LAYER

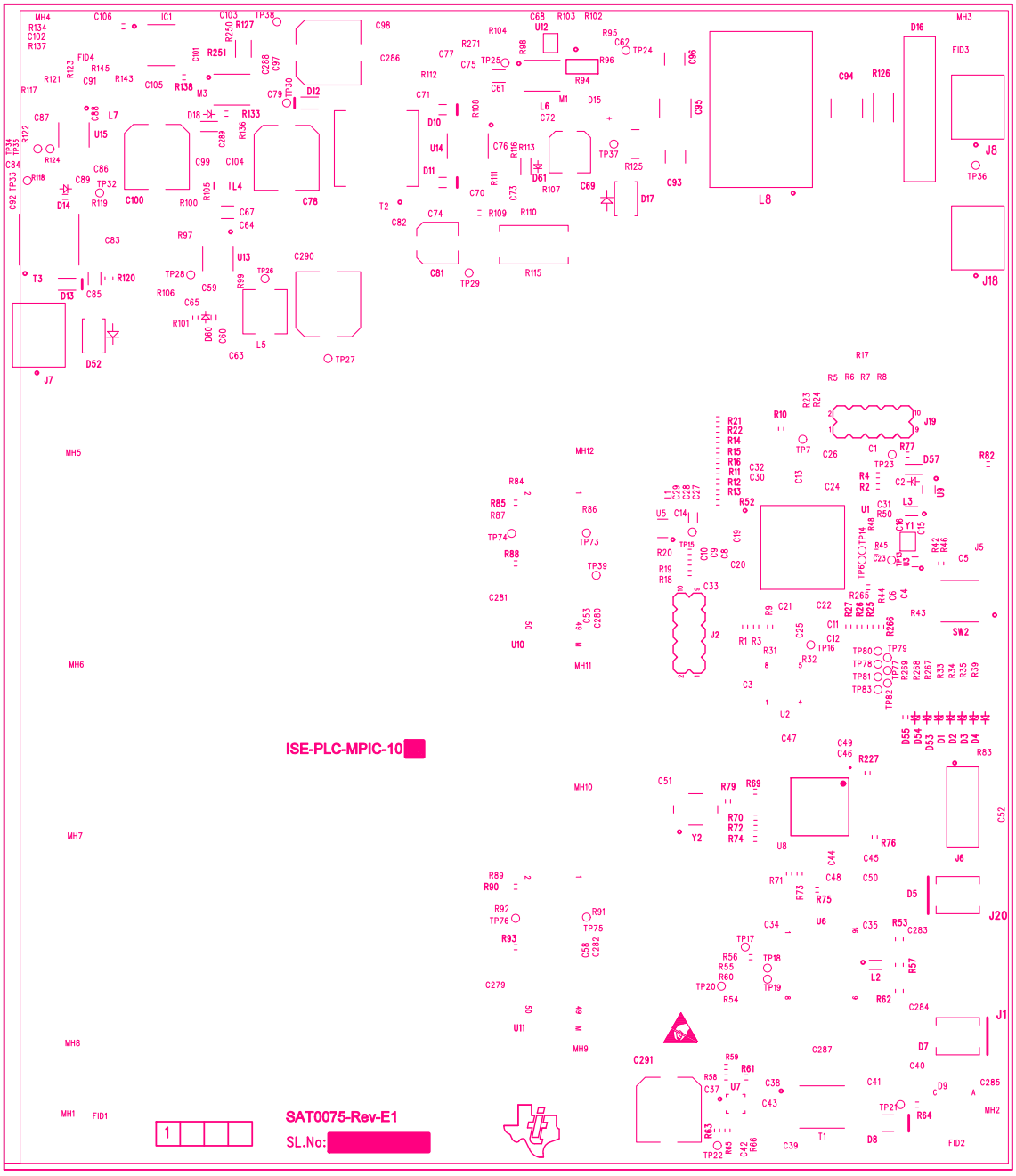

GND SPLIT PLANE



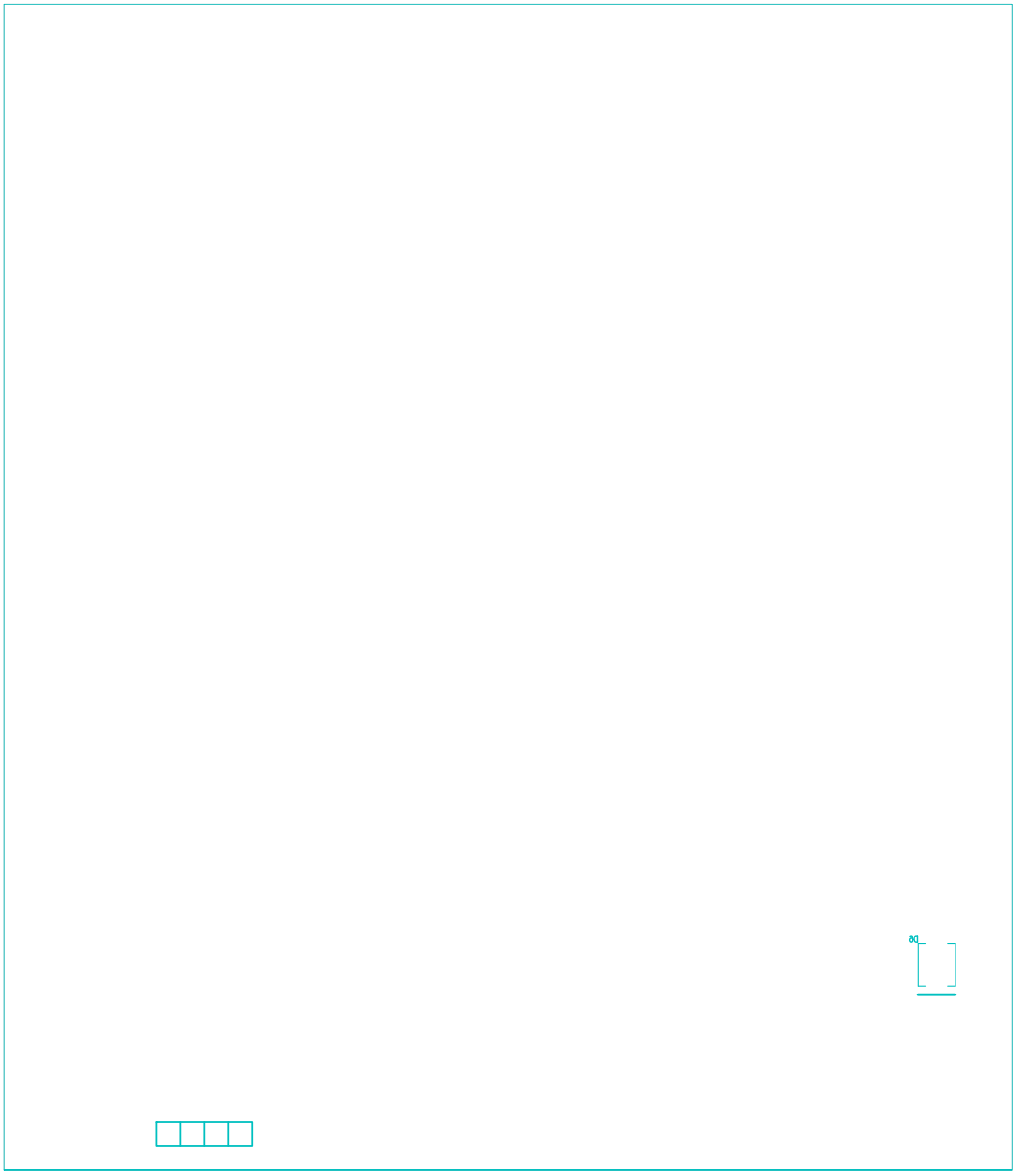

POWER SPLIT PLANE



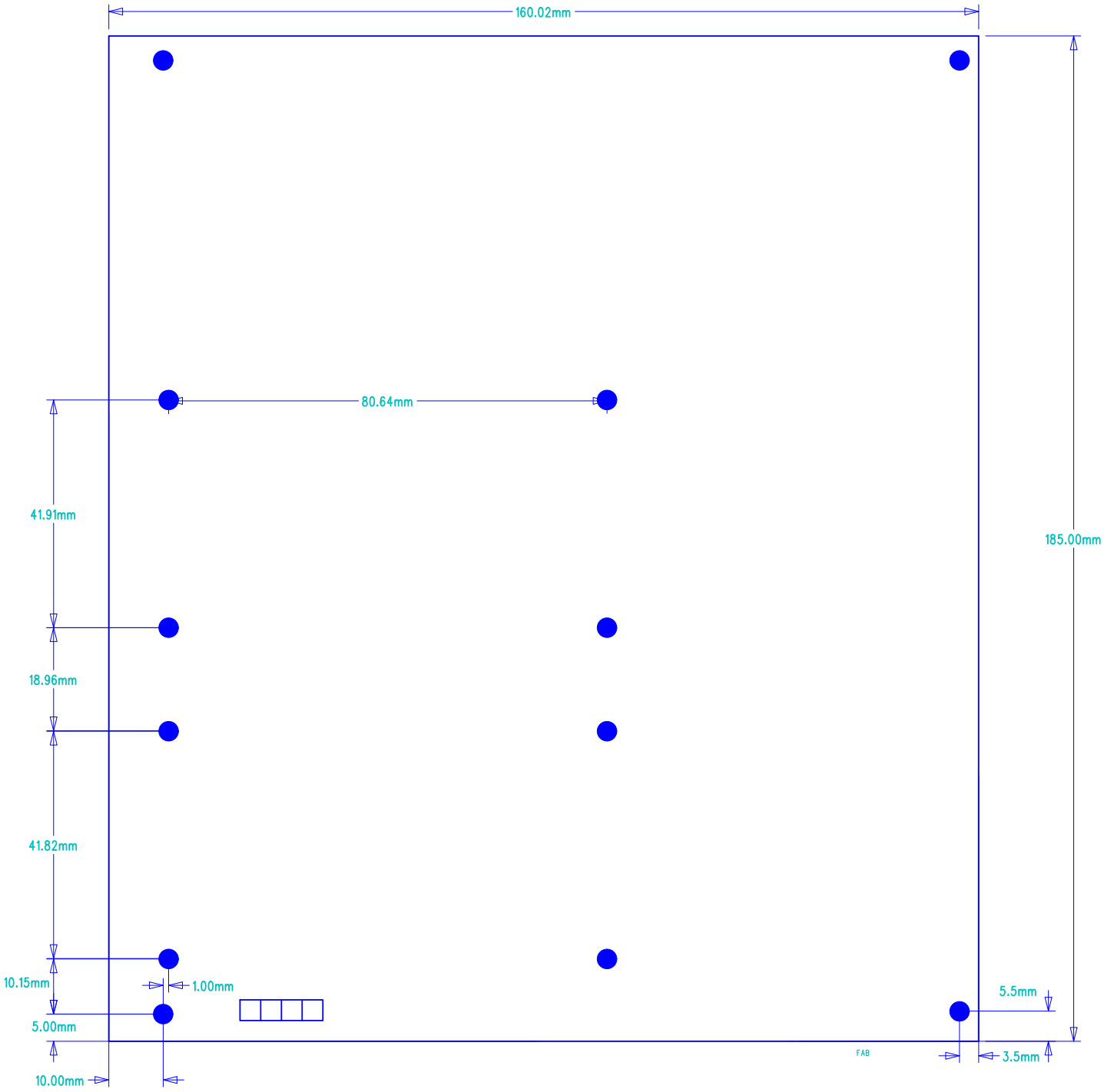

BOTTOM LAYER




SILKSCREEN TOP




SILKSCREEN BOTTOM


160.02mm
80.64mm
41.91mm
18.96mm
41.82mm
10.15mm
5.00mm
10.00mm
1.00mm
185.00mm
5.5mm
3.5mm
FAB

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